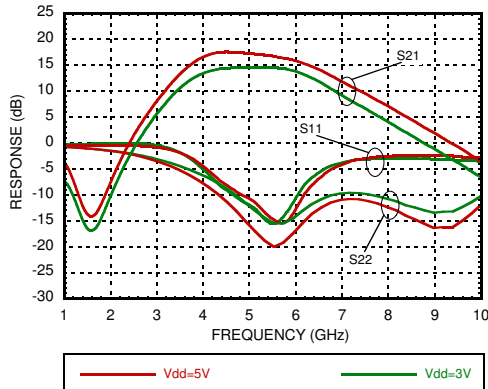
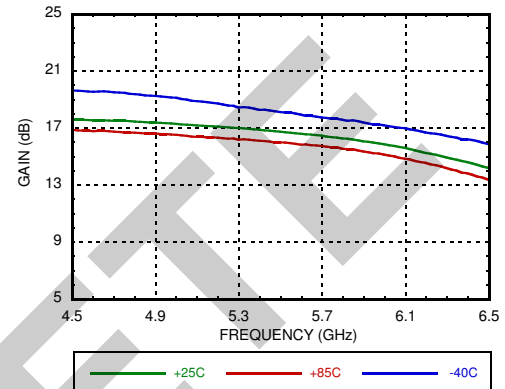


## GAAS PHEMT MMIC LOW NOISE AMPLIFIER, 4.8 - 6.0 GHz

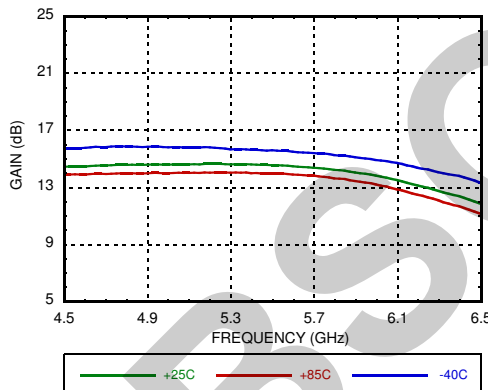
**Broadband Gain & Return Loss [1][2]**



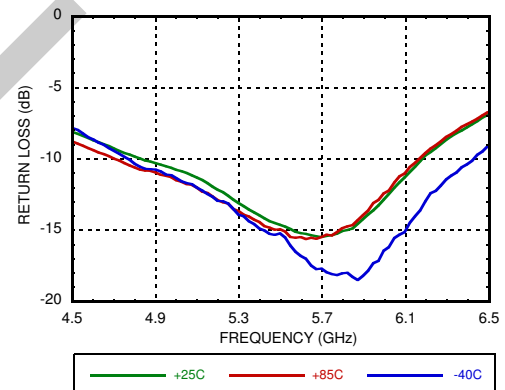
**Gain vs. Temperature [1]**



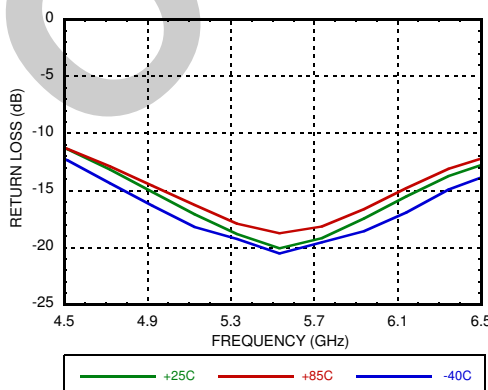
**Gain vs. Temperature [2]**



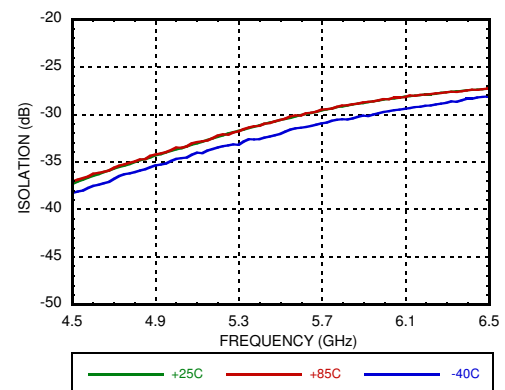
**Input Return Loss vs. Temperature [1]**



**Output Return Loss vs. Temperature [1]**



**Reverse Isolation vs. Temperature [1]**



[1] Vdd = 5V, Rbias = 2kΩ [2] Vdd = 3V, Rbias = 20kΩ



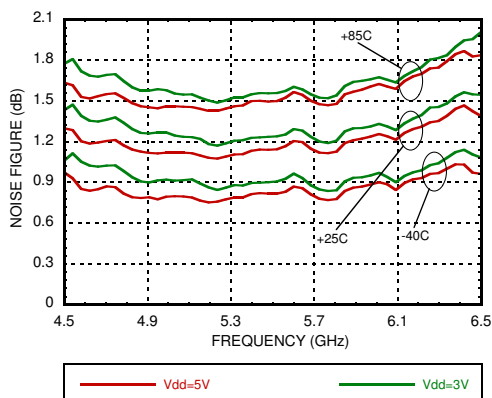
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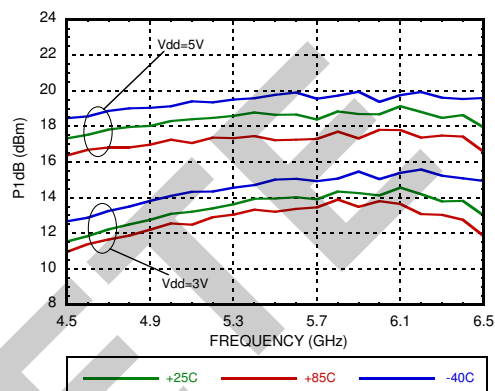
# HMC717LP3E

## GAAS PHEMT MMIC LOW NOISE AMPLIFIER, 4.8 - 6.0 GHz

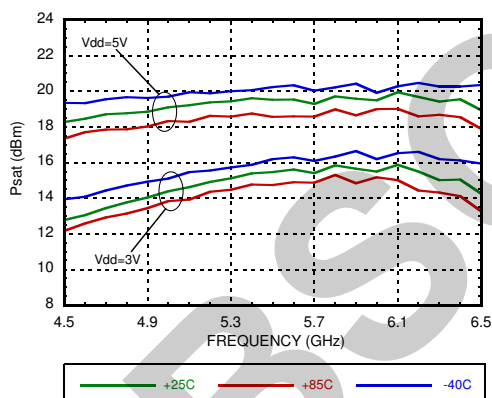
**Noise Figure vs. Temperature [1] [2] [4]**



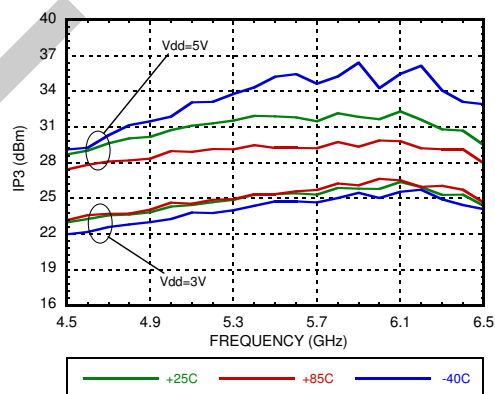
**P1dB vs. Temperature [1] [2]**



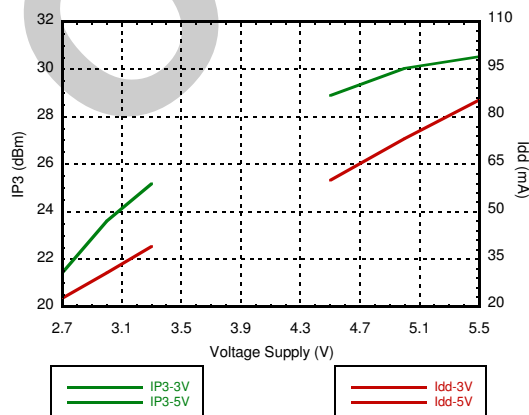
**Psat vs. Temperature [1] [2]**



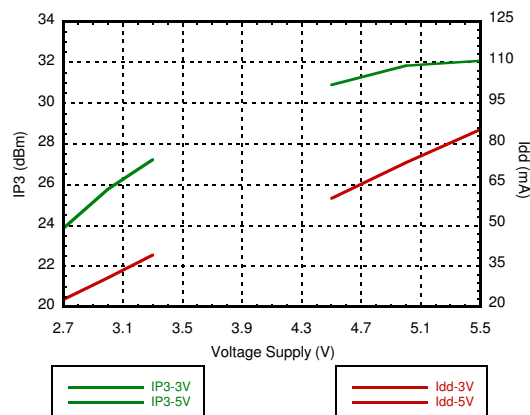
**Output IP3 vs. Temperature [1] [2]**



**Output IP3 and Total Supply Current vs. Supply Voltage @ 4800 MHz [3]**



**Output IP3 and Total Supply Current vs. Supply Voltage @ 5900 MHz [3]**



[1] Vdd = 5V, Rbias = 2k  $\Omega$  [2] Vdd = 3V, Rbias = 20k  $\Omega$

[3] Rbias = 2k  $\Omega$  for Vdd = 5V, Rbias = 20k  $\Omega$  for Vdd = 3V

[4] Measurement reference plane shown on evaluation PCB drawing.

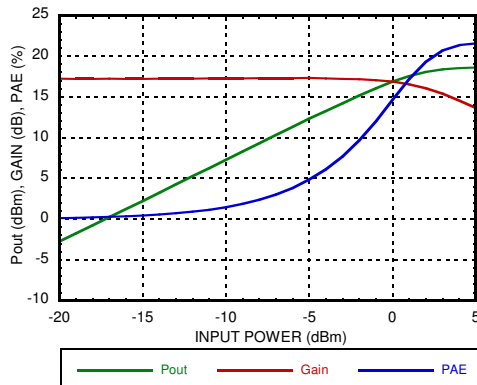
For price, delivery and to place orders: Hittite Microwave Corporation, 2 Elizabeth Drive, Chelmsford, MA 01824

Phone: 978-250-3343 Fax: 978-250-3373 Order On-line at [www.hittite.com](http://www.hittite.com)

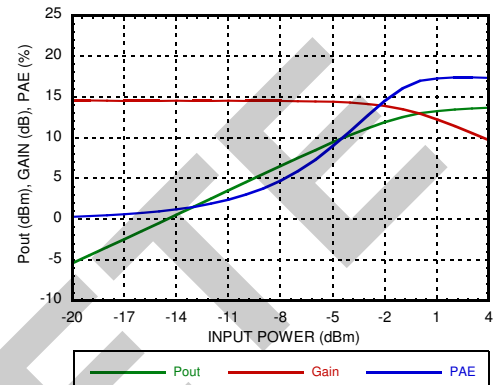
Application Support: Phone: 978-250-3343 or [apps@hittite.com](mailto:apps@hittite.com)

## GAAS PHEMT MMIC LOW NOISE AMPLIFIER, 4.8 - 6.0 GHz

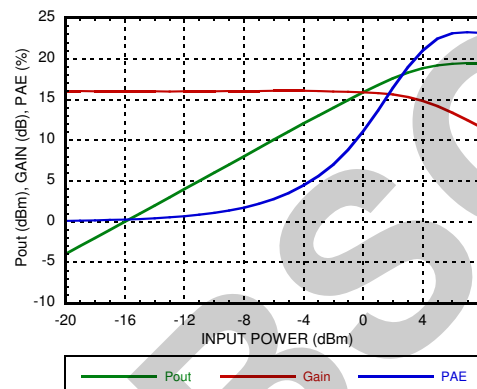
**Power Compression @ 4800 MHz [1]**



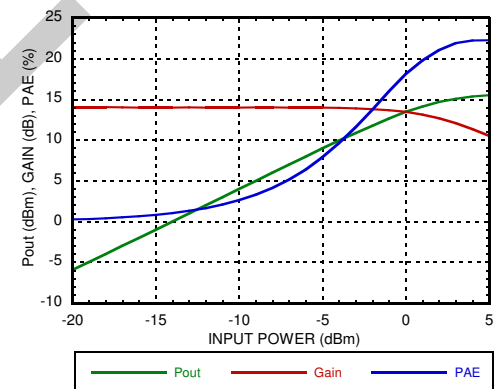
**Power Compression @ 4800 MHz [2]**



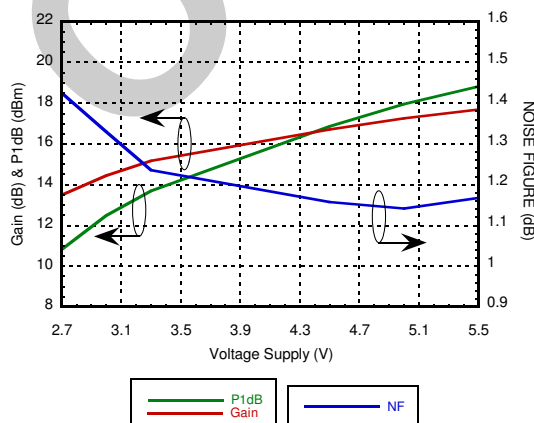
**Power Compression @ 5900 MHz [1]**



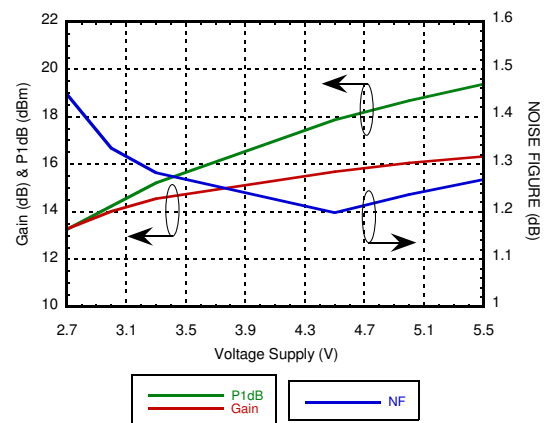
**Power Compression @ 5900 MHz [2]**



**Gain, Power & Noise Figure vs. Supply Voltage @ 4800 MHz [3]**



**Gain, Power & Noise Figure vs. Supply Voltage @ 5900 MHz [3]**



[1] Vdd = 5V, Rbias = 2k  $\Omega$  [2] Vdd = 3V, Rbias = 20k  $\Omega$  [3] Rbias = 2k  $\Omega$  for Vdd = 5V, Rbias = 20k  $\Omega$  for Vdd = 3V



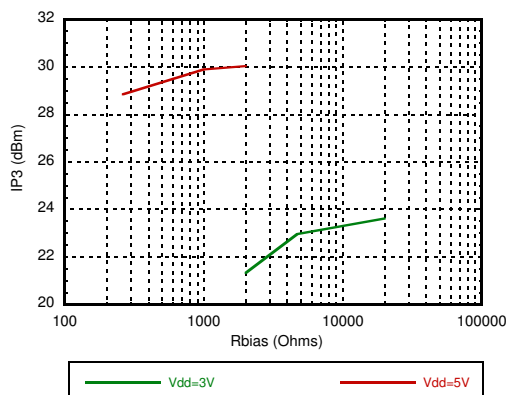
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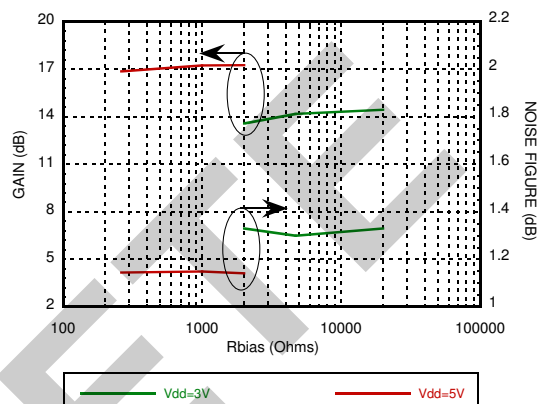
# HMC717LP3E

## GAAS PHEMT MMIC LOW NOISE AMPLIFIER, 4.8 - 6.0 GHz

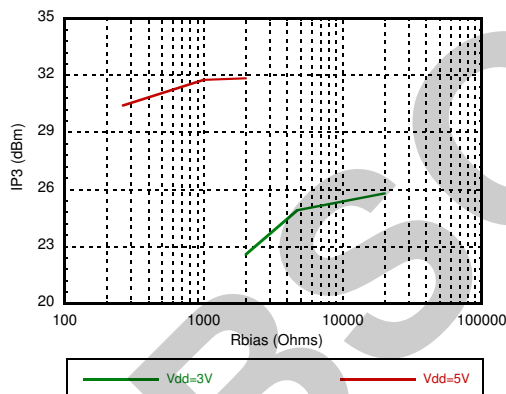
Output IP3 vs. Rbias @ 4800 MHz



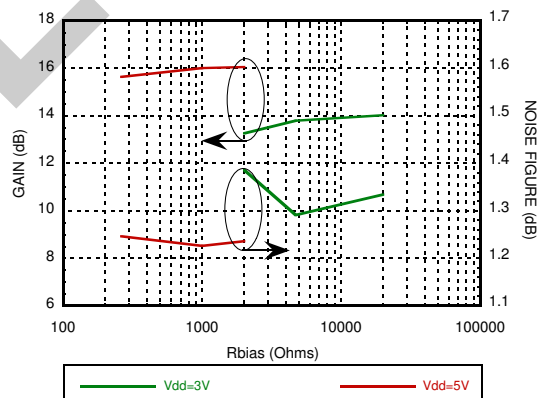
Gain, Noise Figure & Rbias @ 4800 MHz



Output IP3 vs. Rbias @ 5900 MHz



Gain, Noise Figure & Rbias @ 5900 MHz





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## HMC717LP3E

### GAAS PHEMT MMIC LOW NOISE AMPLIFIER, 4.8 - 6.0 GHz

#### Absolute Bias Resistor

#### Range & Recommended Bias Resistor Values

Vdd (V)	Rbias (Ohms)			Idd (mA)
	Min	Max	Recommended	
3V	2k <sup>[1]</sup>	Open Circuit	2k	20
			4.7k	26
			20k	31
5V	150 <sup>[2]</sup>	Open Circuit	261	50
			1k	65
			2k	73

[1] With Vdd= 3V and Rbias < 2k $\Omega$  may result in the part becoming conditionally stable which is not recommended.

[2] With Vdd = 5V and Rbias<150 $\Omega$  may result in the part becoming conditionally stable which is not recommended.

#### Absolute Maximum Ratings

Drain Bias Voltage (Vdd)	+5.5V
RF Input Power (RFIN) (Vdd = +5 Vdc)	+20 dBm
Channel Temperature	150 °C
Continuous P <sub>diss</sub> (T= 85 °C) (derate 7.73 mW/°C above 85 °C)	0.5 W
Thermal Resistance (channel to ground paddle)	129.5 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C
ESD Sensitivity (HBM)	Class 1A



ELECTROSTATIC SENSITIVE DEVICE  
OBSERVE HANDLING PRECAUTIONS

#### Typical Supply Current vs. Supply Voltage

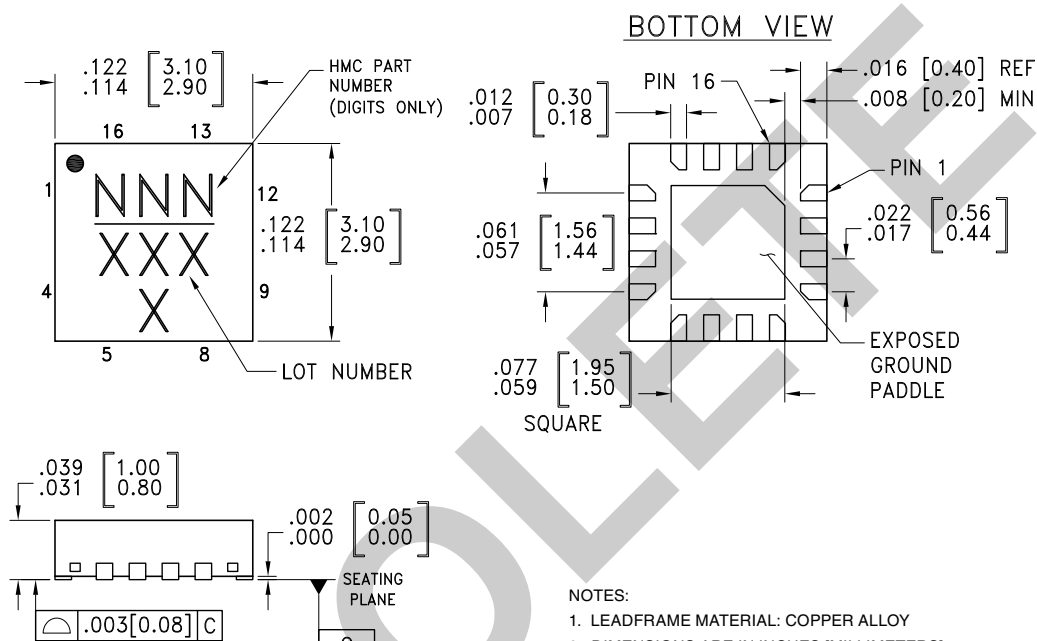
(Rbias = 2k $\Omega$  for Vdd = 5V, Rbias = 20k $\Omega$  for Vdd = 3V)

Vdd (V)	Idd (mA)
2.7	23
3.0	31
3.3	39
4.5	60
5.0	73
5.5	85

Note: Amplifier will operate over full voltage ranges shown above.



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**HMC717LP3E****GAAS PHEMT MMIC LOW NOISE  
AMPLIFIER, 4.8 - 6.0 GHz****Outline Drawing****NOTES:**

1. LEADFRAME MATERIAL: COPPER ALLOY
2. DIMENSIONS ARE IN INCHES [MILLIMETERS]
3. LEAD SPACING TOLERANCE IS NON-CUMULATIVE
4. PAD BURR LENGTH SHALL BE 0.15mm MAXIMUM.  
PAD BURR HEIGHT SHALL BE 0.05mm MAXIMUM.
5. PACKAGE WARP SHALL NOT EXCEED 0.05mm.
6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
7. REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED LAND PATTERN.

**Package Information**

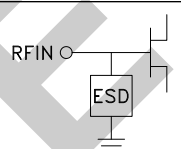
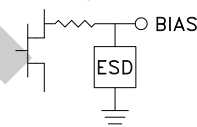
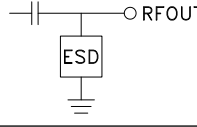
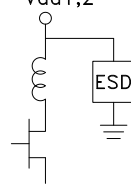
Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking <sup>[3]</sup>
HMC717LP3E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 <sup>[2]</sup>	717 XXXX

[1] Max peak reflow temperature of 235 °C

[2] Max peak reflow temperature of 260 °C

[3] 4-Digit lot number XXXX

### Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1, 3 - 7, 9, 10, 12, 14, 16	N/C	No connection required. These pins may be connected to RF/DC ground without affecting performance.	
2	RFIN	This pin is DC coupled See the application circuit for off-chip component.	
8	BIAS	This pin is used to set the DC current of the amplifier by selection of the external bias resistor. See application circuit.	
11	RFOUT	This pin is AC coupled and matched to 50 Ohms	
13, 15	Vdd2, Vdd1	Power supply voltage. Bypass capacitors are required. See application circuit.	
	GND	Package bottom must be connected to RF/DC ground	